

Electronic Patent Application Fee Transmittal

Application Number:	10644640			
Filing Date:	20-Aug-2003			
Title of Invention:	POLYESTER MOLDING COMPOSITION			
First Named Inventor:	Sung Dug Kim			
Filer:	Marina T. Larson/Lori South			
Attorney Docket Number:	135680-1			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Utility Appl issue fee	1501	1	1400	1400
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				1700